



ESD5V0D5BA

■Maximum Ratings

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	240	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	20	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 30	KV
Junction temperature	T_J	125	$^{\circ}C$
Operating temperature	T_{OP}	-40~85	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				± 5.0
Reverse leakage current	I_R	nA	$V_{RWM} = 5V$			100
Reverse breakdown voltage	V_{BR}	V	$I_{BR} = 1mA$	5.1		
Reverse holding voltage	V_{HOLD}	V	$I_{HOLD} = 50mA$	5.1		
Clamping voltage ¹⁾	V_{CL}	V	$I_{PP} = 16A, t_p = 100ns$		8	
Dynamic resistance ¹⁾	R_{DYN}	Ω			0.22	
Clamping voltage ²⁾	V_{CL}	V	$V_{ESD} = 8kV$		8	
Clamping voltage ³⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$		6.5	8
		V	$I_{PP} = 20A, t_p = 8/20\mu s$		10	12
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		35	45
		pF	$V_R = 2.5V, f = 1MHz$		33	40

(1). TLP parameter: $Z_0 = 50\Omega, t_p = 100ns, t_r = 2ns$, averaging window from 60ns to 80ns. R_{DYN} is calculated from 4A to 16A.

(2). Contact discharge mode, according to IEC61000-4-2.

(3). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

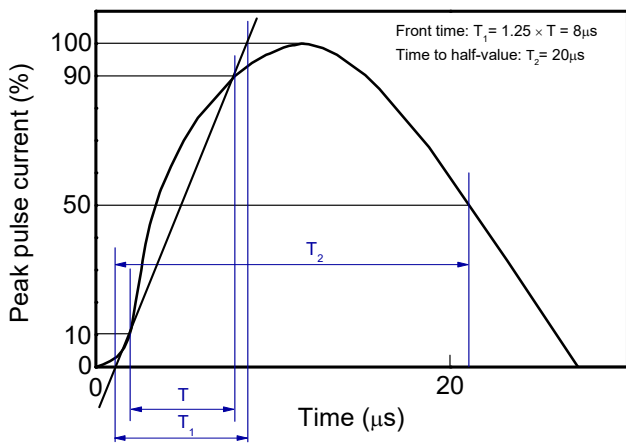
PREFERRED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD5V0D5BA	Approximate 2	10000	100000	400000	Tape & reel



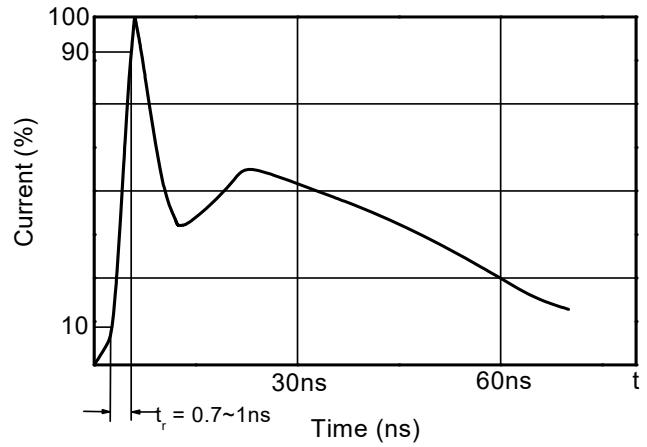
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■ Characteristics (Typical)

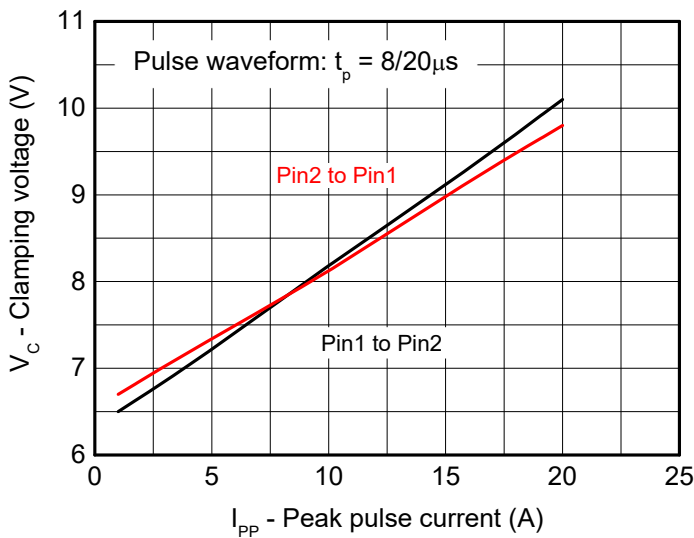
8/20μs waveform per IEC61000-4-5



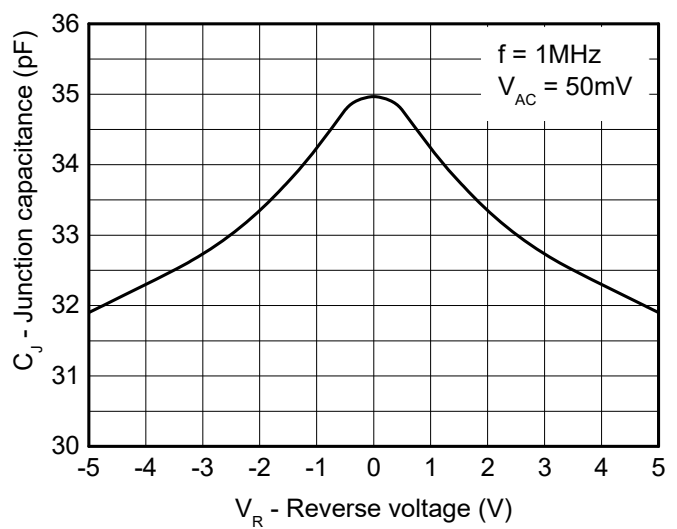
Contact discharge current waveform per IEC61000-4-2



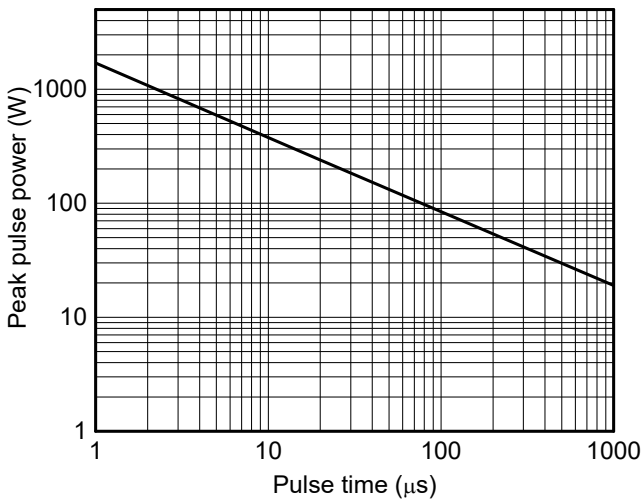
Clamping voltage vs. Peak pulse current



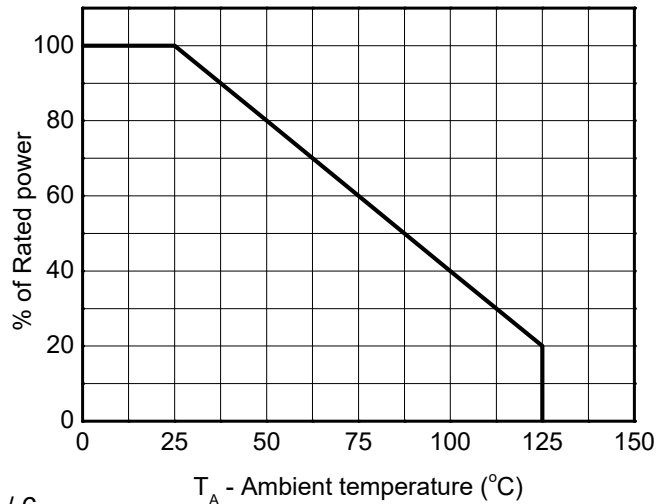
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time



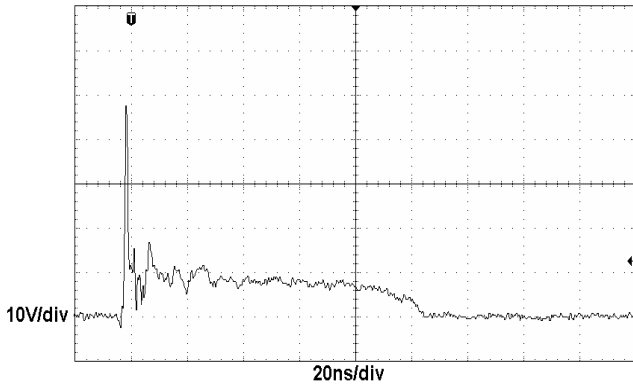
Power derating vs. Ambient temperature



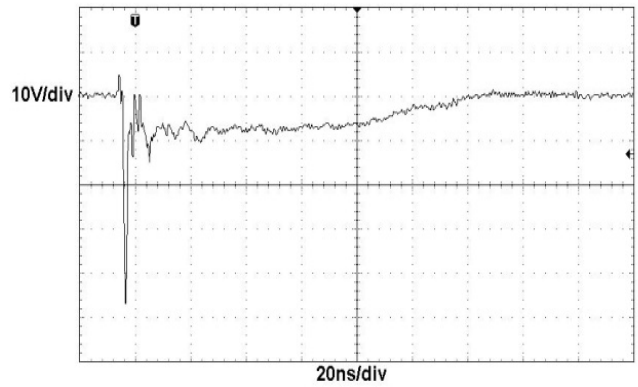


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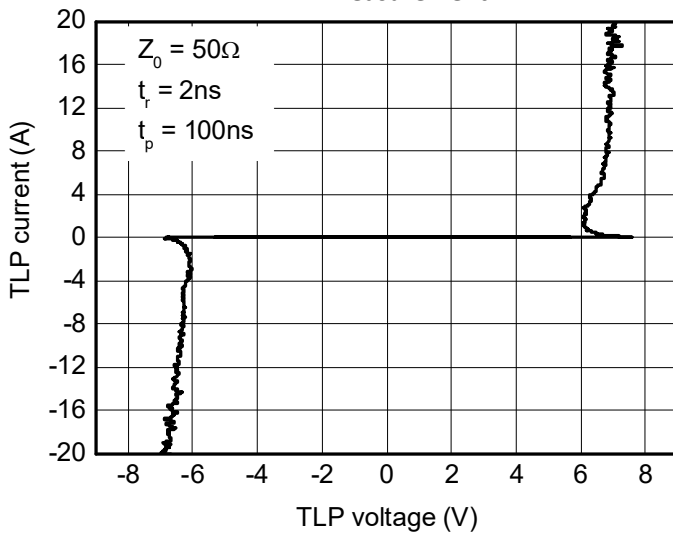
ESD clamping
(+8kV contact discharge per IEC61000-4-2)



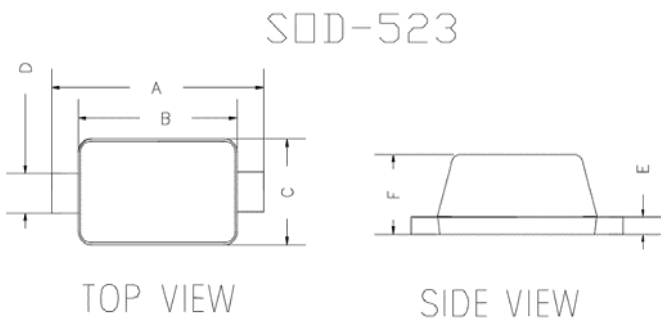
ESD clamping
(-8kV contact discharge per IEC61000-4-2)



TLP Measurement



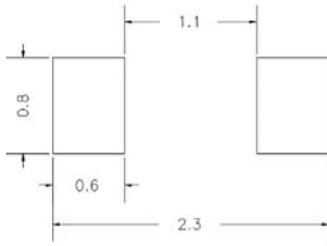
■ **Outline Dimensions**



DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.059	0.067	1.500	1.700
B	0.043	0.051	1.100	1.300
C	0.028	0.035	0.700	0.900
D	0.010	0.014	0.250	0.350
E	0.002	0.008	0.050	0.200
F	0.020	0.028	0.500	0.700



■ Recommend land pattern (Unit:mm)



UNIT : mm

SUGGESTED SOLDER PAD LAYOUT

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



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